



Customer Information Notification

201703003I

Issue Date: 15-Mar-2017
Effective Date: 16-Mar-2017

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online



QUALITY

Change Category

- | | | | | |
|--|---|--|---|--|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input checked="" type="checkbox"/> Electrical spec./Test coverage |

MPC5748G Cut2.0 Rev 4 Datasheet Announcement

Information Notification

NXP Semiconductor is pleased to announce the release of MPC5748G Rev 4 datasheet.

The revision history included in the updated documents provides a detailed description of the changes.

The updated document can also be found at <http://www.nxp.com> and search for MPC5748G.

Why do we issue this Information Notification

To provide additional and updated information related to the MPC5748G family from previous revision.

Identification of Affected Products

Product identification does not change

Impact

Improved functionality and enhanced feature set from previous revision.

Data Sheet Revision

A new datasheet will be issued

Disposition of Old Products

MPC5748G, maskset 1N81M Cut 2.0 will continue to run in production until further notice.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Paul Oates
Position Customer Program Management Automotive Microcontrollers and Processors
e-mail address paul.oates@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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Changed Orderable Part#	Changed Part 12NC	Changed Part Number	Changed Part Description	Package Name	Status	Product Line
SPC5748GK1MMN6	935316042557	SPC5748GK1MMN6	"32 BIT,6MB FLASH,768 RAM"	LBGA324	CQS	BL Auto Micro Processors
SPC5748GGK1MMJ6	935316302557	SPC5748GGK1MMJ6	"32 BIT,6MB FLASH,768 RAM"	LBGA256	RFS	BL Auto Micro Processors
SPC5748GK1MKU6	935322387557	SPC5748GK1MKU6	"32 BIT,6MB FLASH,768 RAM"	HLQFP176	CQS	BL Auto Micro Processors
SPC5748GK1MMJ6	935312772557	SPC5748GK1MMJ6	"32 BIT,6MB FLASH,768 RAM"	LBGA256	RFS	BL Auto Micro Processors